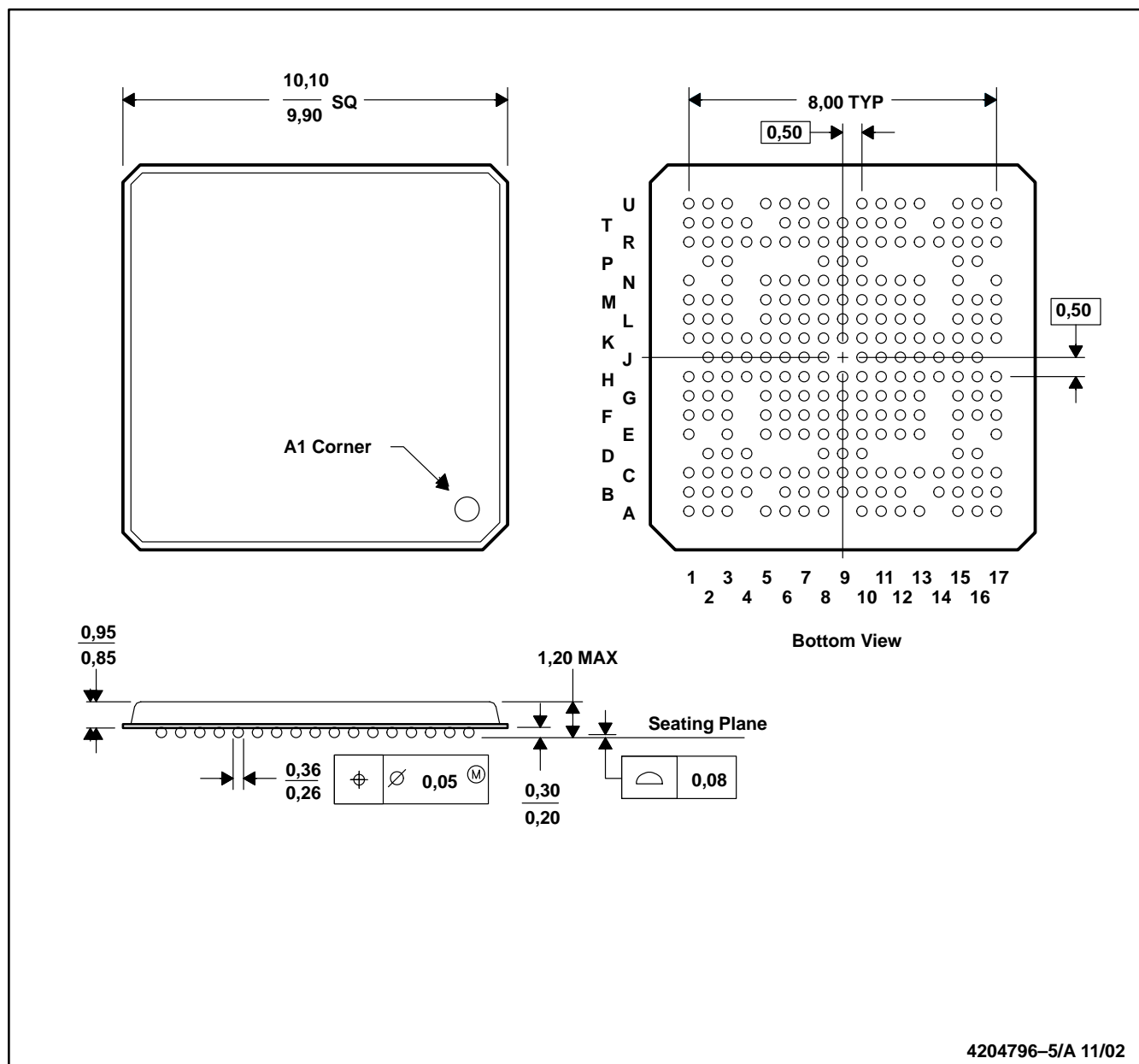


## ZPH (S-PBGA-N241)

## PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. MicroStar BGA™ configuration
  - D. This package is lead-free.

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